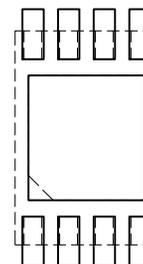
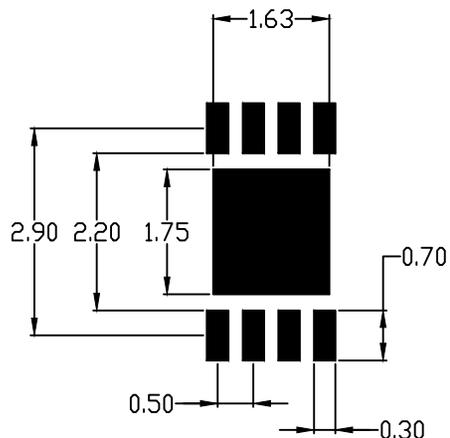


RECOMMENDED LAND PATTERN  
(For generic Package codes and Products)

PACKAGE OVERLAY



NOTES:

1. REFERENCE PKG. OUTLINE: 21-0174, 21-100417
2. LAND PATTERN COMPLIES TO: IPC7351A.
3. TOLERANCE: +/- 0.02 MM.
4. ALL DIMENSIONS APPLY TO BOTH LEADED (-) AND PbFREE (+) PKG. CODE.
5. ALL DIMENSIONS IN MM.

-DRAWING NOT TO SCALE-

PKG CODES

[T823+1]  
[T823+1C]  
[T823+2]  
[T823+3C]  
[T823Y+3]  
[T823Y+3C]



This document (including dimensions, notes & specs) is a recommendation based on typical circuit board manufacturing parameters. Since land pattern design depend on many factors unknown to Analog Devices (eg. user's board manufacturing specs), user must determine suitability for use. This document is subject to change without notice. Contact technical support at <http://www.maxim-ic.com/support> for further questions.

TITLE:  
PACKAGE LAND PATTERN,  
[T8] 2x3x0.75mm TDFN, 8 LEADS

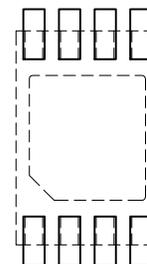
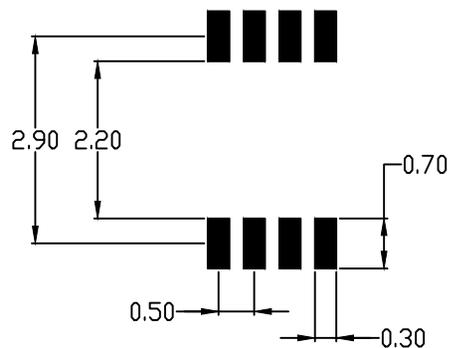
APPROVAL  
JUN WU

DOCUMENT CONTROL NO.  
90-0091

REV. I 1/2

RECOMMENDED LAND PATTERN  
 (For product MAX6078, MAX16193 only)

PACKAGE OVERLAY



NOTES:

1. LAND PATTERN EXPOSED PAD PORTION REMOVED FOR PERFORMANCE CONSIDERATIONS.

—DRAWING NOT TO SCALE—



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TITLE:  
 PACKAGE LAND PATTERN,  
 [T8] 2x3x0.75mm TDFN, 8 LEADS

APPROVAL JUN WU	DOCUMENT CONTROL NO. 90-0091	REV. I	2/2
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